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## ABSTRACT OF THE DISCLOSURE

A method of forming a conductive device includes forming a conductive layer on a substrate; etching the conductive layer to form a plurality of conductive traces; etching the conductive layer to form at least one mask feature; and removing substrate material that is not covered by the at least one mask feature so as to form at least one mechanical alignment feature.



## $M:\clients\S\STK\00046 pus\application.wpd$

Revised - 08/15/00, Mark

08/25/00, Mark

09/10/00, Mark

5 09/11/00, Shelly

09/13/00, Shelly

10/05/00, Mark

10/05/00, Shelly